



IXYS Corporation USA

Sept. 9, 2017

Certificate of Compliance RoHS 2

Herewith we confirm that

IXYS Devices and Chip Products

are in compliance with the requirements detailed in the

DIRECTIVE 2011/65/EU of the EUROPEAN PARLIAMENT and of the COUNCIL

Effective January 3, 2013

Exception: IXYS devices currently uses a high temperature leaded solder for chip attach allowable under RoHS exemption 7A until 2019 per Directive 2016/774/EU as of 18 May 2016 amending Annex II to Directive 2000/53/EC. The prior wording for 8e (RoHS 7a) was retained and will be reviewed in 2019 by the EUC.

7(a)	Lead in high melting temperature type solders (i.e. lead- based alloys containing 85 % by weight or more lead)
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